



Mag Layers USA, INC

Specification Sheet

P/N : **MCM-0905-901-E-RU**

Products:

[Molded Power Chokes](#)

[Multilayer Chip Inductors](#)

[Lan Transformer](#)

[RF Passive / Antennas](#)

[Automotive](#)

Certifications:

[ISO9001](#)

[IATF16949](#)

[ISO14001](#)

[QC080000](#)

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I . SCOPE :

This specification applies to the Pb Free DC Power Line Common Mode Filter
for MCM-0905-901-E

PRODUCT IDENTIFICATION

MCM - 0905 - 901- E-RU

① ② ③ ④

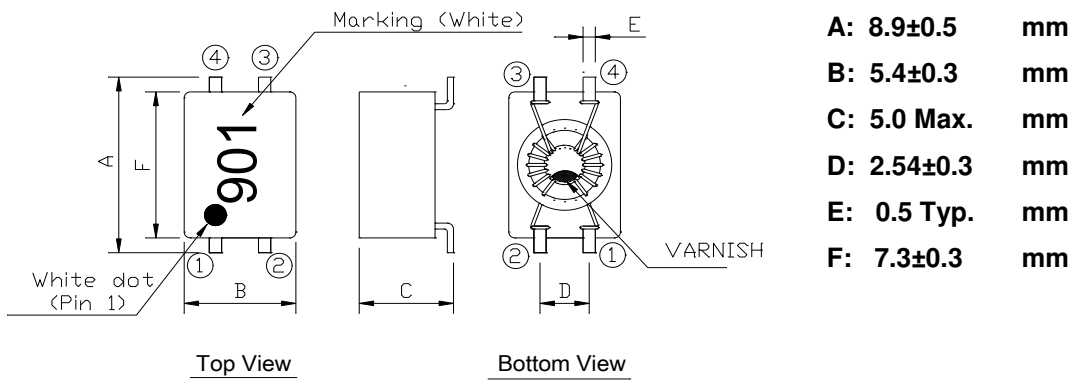
- ① Product Code
- ② Dimensions Code
- ③ Impedance Code
- ④ Inner Control Code

II . INDEX :

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<p>Unless otherwise specified, test condition should be Temp. = 20±5℃, Humidity = 35~85%</p> <p>But if needed, then test condition should be Temp. = 20±2℃, Humidity = 65±5%</p> <p>8. SHELF LIFE</p> <p>Storage Condition: The temperature should be within -40℃ ~ 105℃ and humidity should be less than 75%RH. The product should be used within 12 months from the time of delivery.</p> <p>In addition, suggest to use product within 6 months from the time of delivery.</p>		



(1) SHAPES AND DIMENSIONS



(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

Z : HP E4991A RF Impedance/Material Analyzer (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

I.R : CHROMA MODEL 19073 AC/DC/IR HIPOT TESTER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range -40°C ~ +125°C

(Including self temp. rise)

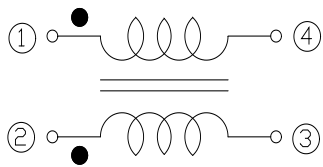
(3)-2 Storage temperature range -40°C ~ +125°C

TABLE 1

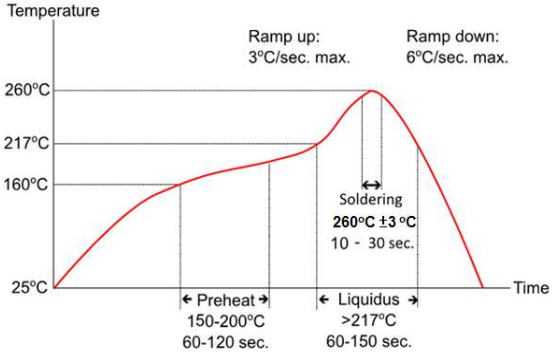
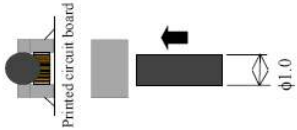
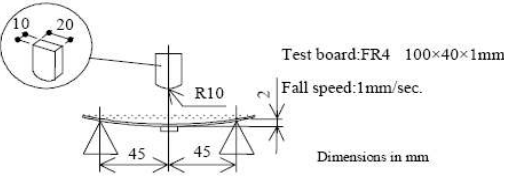
MAGLAYERS PT/NO.	Impedance(Ω) at 100MHz		Withstanding Voltage AC (V)	Resistance RDC (m Ω) Max. (1 line)	Rated Current (A)	Insulation Resistance (M Ω) Min.	Rated Voltage DC (V) Max.
	Min.	Typ.					
MCM-0905-901-E-RU	200	900	125	65	2.0	100	50

Rated Current :Based on temperature rise (ΔT : 40 $^{\circ}$ C Typ.)

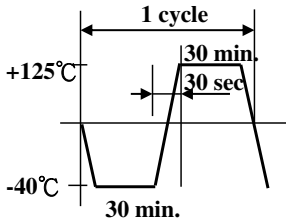
CIRCUIT DIAGRAM



**(4) RELIABILITY TEST METHOD
MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Solder ability	The product shall be connected to the test circuit board by the fillet (the height is 0.2mm).	Apply cream solder to the printed circuit board . Refer to clause 8 for Reflow profile.
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	<p>Temperature profile of reflow soldering</p>  <p>Note: 1. Re-Flow Possible times: within 2 times 2. Nitrogen adopted is recommended while in re-flow</p>
Terminal strength	The terminal electrode and the ferrite must not be damaged.	<p>Solder a chip to test substrate , and then laterally apply a load 9.8N in the arrow direction.</p> 
Strength on PC board bending	The terminal electrode and the ferrite must not be damaged.	<p>Solder a chip to test substrate and then apply a load.</p> 
High temperature resistance	<p>Impedance: Within $\pm 20\%$ of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : $+125 \pm 2^\circ\text{C}$</p> <p>Applied voltage : Rated voltage</p> <p>Applied current : Rated current</p> <p>Testing time : 500 ± 12 hours</p>

(4) RELIABILITY TEST METHOD
MECHANICAL

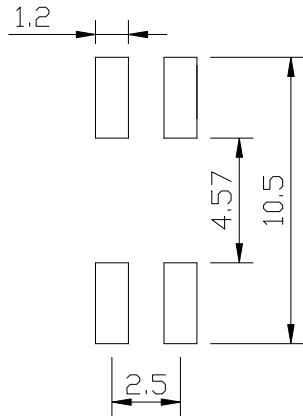
TEST ITEM	SPECIFICATION	TEST DETAILS
Humidity resistance	<p>Impedance: Within $\pm 20\%$ of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : $+60 \pm 2^\circ\text{C}$, Humidity : 90 to 95 %RH</p> <p>Applied voltage : Rated voltage</p> <p>Applied current : Rated current</p> <p>Testing time : 500 ± 12 hours</p>
Thermal shock	<p>Impedance: Within $\pm 20\%$ of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	 <p>Testing Time: 100 cycle</p>
Low temperature storage	<p>Impedance: Within $\pm 20\%$ of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : $-40 \pm 2^\circ\text{C}$</p> <p>Testing time : 500 ± 12 hours</p>
Vibration	<p>Impedance: Within $\pm 20\%$ of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Frequency : 10 to 55 Hz</p> <p>Amplitude : 1.52 mm</p> <p>Dimension and times : X , Y and Z directions for 2 hours each.</p>
Solderability	<p>New solder More than 75%</p>	<p>Flux (rosin, isopropyl alcohol {JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of $130 \sim 150^\circ\text{C}$ and after it has been immersed to a depth 0.5mm below for 3 ± 0.2 seconds fully in molten solder M705 with a temperature of $245 \pm 2^\circ\text{C}$. More than 75% of the electrode sections shall be covered with new solder smoothly when the sample is taken out of the solder bath.</p>

(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY $t=1.6\text{mm}$

(5)-1 LAND PATTERN DIMENSIONS

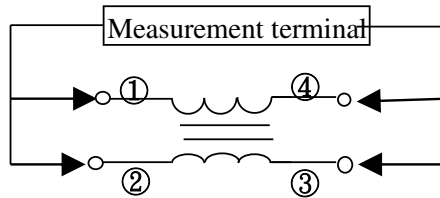
(STANDARD PATTERN)



(6) TEST EQUIPMENT

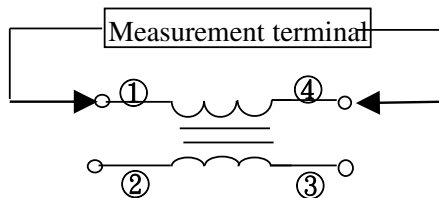
(6)-1 Impedance

Measured by using HP4291B RF Impedance Analyzer.



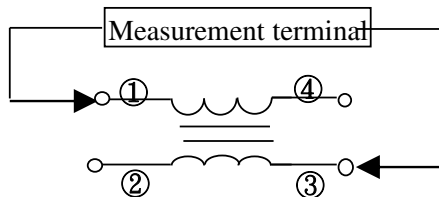
(6)-2 DC Resistance

Measured by using Chroma 16502 milliohm meter.



(6)-3 Insulation Resistance

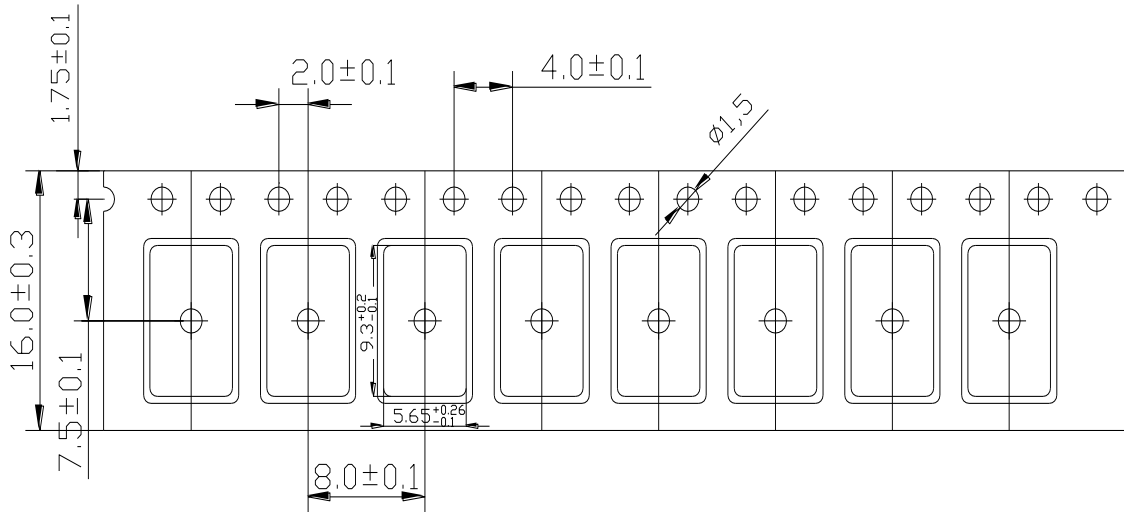
Measured by using Chroma 19073



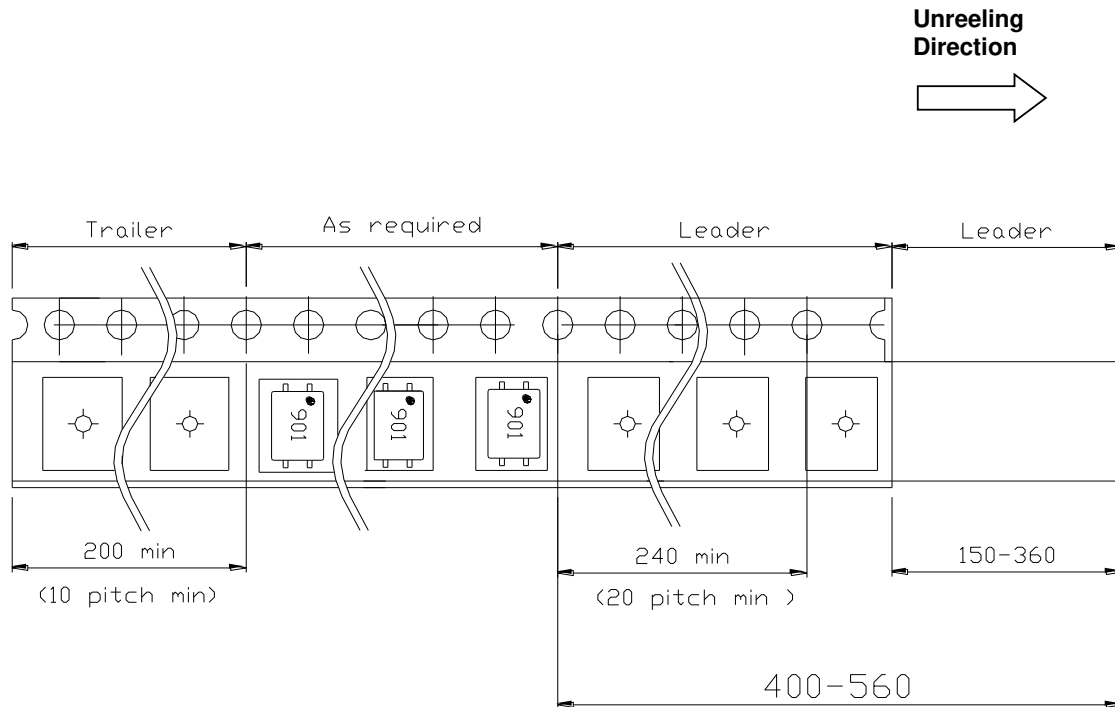
MAG.LAYERS

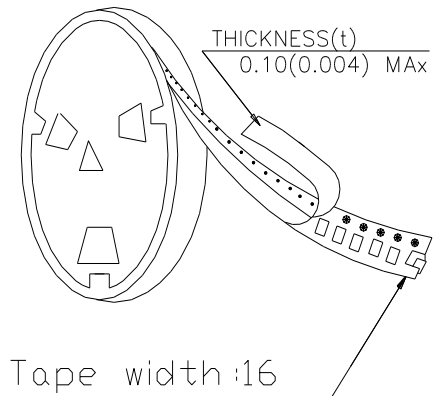
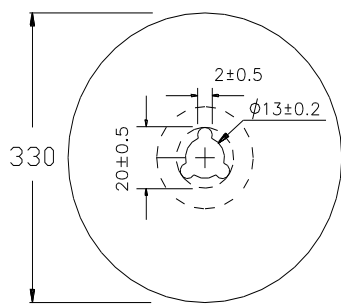
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)



(6)-2 TAPING DIMENSIONS (mm)





(6)-4 QUANTITY

1000 pcs/Reel

The products are packaged so that no damage will be sustained.

TYPICAL ELECTRICAL CHARACTERISTICS

FREQUENCY VS. IMPEDANCE

